PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

| Name | Execution Date |
|----------------|----------------|
| YOUNG BANG LEE | 11/19/2009 |

RECEIVING PARTY DATA

| Name: | HYNIX SEMICONDUCTOR INC. |
|-----------------|---|
| Street Address: | SAN 136-1, AMI-RI, BUBAL-EUP, ICHEON-SI |
| City: | GYEONGGI-DO |
| State/Country: | REPUBLIC OF KOREA |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 12634889 |

CORRESPONDENCE DATA

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NAME OF SUBMITTER: Woochoon W. Park

Total Attachments: 2

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PATENT REEL: 023634 FRAME: 0064 CH \$40.00 126

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UNITED STATES OF AMERICA ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNOR:

Name: Young Bang LEE

Address: #501, Taechang Villa B-dong, 594-24, Juan 2-dong 23/3, Nam-gu, Incheon Metropolitan

City, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

ASSIGNEE:

Name: Hynix Semiconductor Inc.

Address: San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:

METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE HAVING A DUAL GATE INSULATION LAYER

(TITLE)

| and which is found in (check one applicable item below | v) |
|--|--|
| U.S. patent application executed on ev | ven date herewith |
| U.S. Application Serial No. | filed on |
| and, in and to all Letters Patent to be obtained to | for said invention by the above application or any |

ASSIGNOR hereby convenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further convenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent

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and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

November 19, 2009

Date

INVENTOR: Young Bang LEE

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특허문서

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RECORDED: 12/10/2009

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